

SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

CPH5512 -

Silicon Epitaxial Type Pin Diode for VHF, UHF, AGC Applications

Features

- · Composite type with 2 diodes contained in a CPH package currently in use, improving the mounting efficiency greatly
- Small interterminal capacitance (C=0.23pF typ)
- Small forward series resistance ($r_s=5\Omega$ typ)

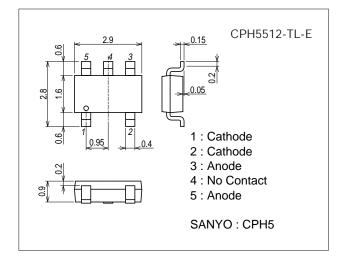
Specifications

Absolute Maximum Ratings at Ta=25°C

| Parameter | Symbol | Conditions | Ratings | Unit |
|-----------------------------|--------|------------|-------------|------|
| Reverse Voltage | VR | | 50 | V |
| Forward Current | lF | | 50 | A |
| Allowable Power Dissipation | P | | 350 | V |
| Junction Temperature | Tj | | 125 | °C |
| Storage Temperature | Tstg | | -55 to +125 | °C |

Package Dimensions

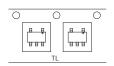
unit : mm (typ) 7017A-001



Product & Package Information

- Package : CPH5
- JEITA, JEDEC : SC-74A, SOT-25
- Minimum Packing Quantity : 3,000 pcs./reel

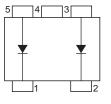
Packing Type : TL





Marking

Electrical Connection



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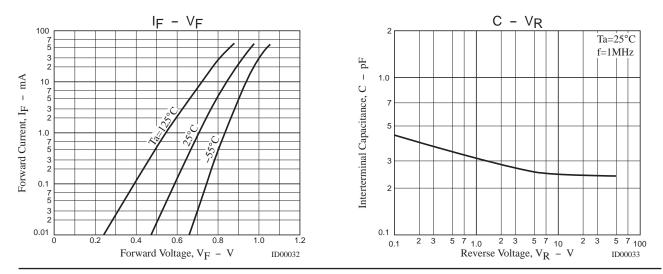
Electrical Characteristics at Ta=25°C

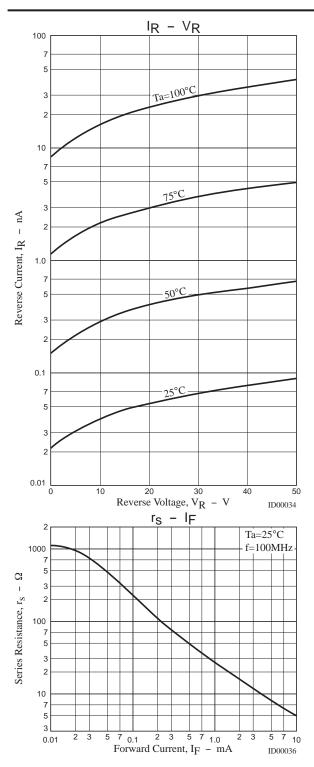
| Parameter | Sumbol | Conditions | | Unit | | | |
|---------------------------|--------|-----------------------------|-----|------|-----|------|--|
| Faianietei | Symbol | Conditions | min | typ | max | Unit | |
| Reverse Voltage | VR | I _R =10μA | 50 | | | V | |
| Reverse Current | IR | V _R =50V | | | 0.1 | μΑ | |
| Forward Voltage | VF | IF=50mA | | 0.95 | | V | |
| Interterminal Capacitance | С | V _R =50V, f=1MHz | | 0.23 | | pF | |
| SeriesResistance | rs | IF=10mA, f=100MHz | | 5 | | Ω | |

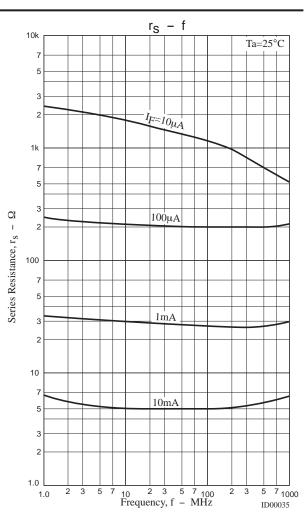
The specifications shown above are for each individual diode.

Ordering Information

| Device | Device Package | | memo | | |
|-------------------|----------------|----------------|---------|--|--|
| CPH5512-TL-E CPH5 | | 3,000pcs./reel | Pb Free | | |







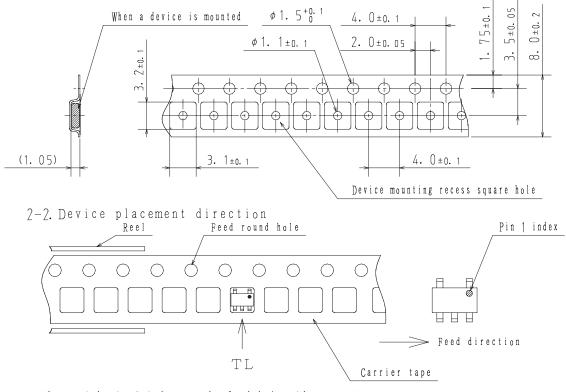
Embossed Taping Specification CPH5512-TL-E

1. Packing Format

| Package Name | Carrier Tape | Tape Maximum Number of devices contained (pcs) | | | Packing format | | | |
|--------------|--|--|-----------|--------------------------------------|----------------|------------------------|---------------------------------------|--|
| | Туре | Reel | Inner box | Outer box | In | ner BOX | (C-1) | Outer BOX (A-7) |
| CPH5 | CPH6 | 3,000 | 15,000 | 90,000 | 5 ree | els contain | e d | 6 inner boxes contained |
| | | | | | Dime | nsions:mm | (externa | l) Dimensions:mm (external) |
| | | | | | 18 | 3×72> | < 1 8 5 | 440×195×210 |
| | Reel label, Inner box label Outer box label | | | | | | | |
| Packing met | Packing method (unit:mm) It is a label at the time of factory shipme The form of a label may change in physical distribution process. | | | | | | orm of a label may change in physical | |
| 0 | < | | < | E | 59 | | Ļ | 108 |
| | Type LOT Quan Orig | No. tity in | | IIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIII | | AD FREE * | 80 | TYPE CODE ************************************ |
| | <u>Reel</u> la | IDEI | | | | descriptio terminal | | that the surface free. |
| | | | | Label | l | JEITA | Phase | |
| | | | | LEAD FRI | EE 3 | JEITA | Phase 3 | A |
| | | | | LEAD FRI | EE 4 | JEITA | Phase 3 | |

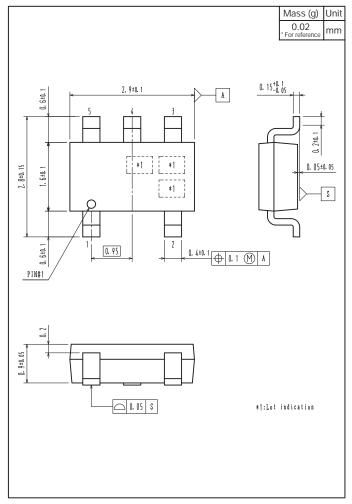
2. Taping configuration

2-1. Carrier tape size (unit:mm)

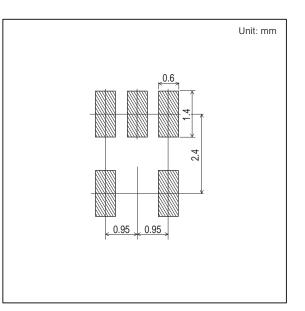


Those with pin 1 index on the feed hole side $\cdots \cdots TL$

Outline Drawing CPH5512-TL-E



Land Pattern Example



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